SC2647
Multi-Platform Multi-Phase PWM Controller

Description

The SC2647 provides microprocessor core voltage regulation solution up to 4 paralleled PWM channels. The solution can also be configured as 2, 3, or 4-phase form. Multi-phase buck regulator utilizes the phase-shift timing control to allow interleaved switching of the power switches. This architecture minimizes the core voltage ripple and the input current ripple, which leads to optimized voltage regulator design for power density, transient responses, and the thermal performances.

To satisfy the highly dynamic nature of the modern microprocessors, the SC2647 adopts peak current mode control topology which ensures wide control loop bandwidth and fast transient responses. The current mode control provides intrinsic phase current matching. The maximum ripple frequency is greater than 1MHz.

One of the outstanding features of the SC2647 is its voltage regulation accuracy. Not only it provides better than 0.5% set point accuracy, but also the accuracy to fully complaint with the stringent load line slope specifications mandated by the modern microprocessors. Lossless output current sensing ensures the regulator output voltage is accurately positioned according to the load current condition, and an internal temperature compensation technology further enhances the performance of voltage accuracy.

The patented Combi-Sense™ topology is employed by SC2647. The MOSFET $R_{ds(on)}$ and the output inductor winding resistance is used to generate the phase current information. The SC1211VX Combi-Sense™ MOSFET driver plus the SC2647 enables the complete solution.

The SC2647 is a multi-platform controller. It conforms to Intel VRM/VRD10.0, VRM9.X, and AMD K-8 (Opteron™) VID specifications. With very minor changes of the schematic and the layout, the SC2647 based solution can be ported form one platform to another. This greatly benefits the system manufactures for reductions of design cycle and minimize the inventory management.

The VID structure of the SC2647 supports VID-on-Fly applications for any platform. The cycle-by-cycle current limit plus the intelligent over current shut down provide the maximum versatility of the system without false tripping under all possible changes of VID and load conditions. The differential voltage feedback sense eliminates the error caused by high load current on the ground plane. External offset is easy to achieve for any platforms and the VID settings. The enable function is also provided to interface with the corresponding system signal for correct start up timing and shut down timing.

(Multiple Patents Pending)

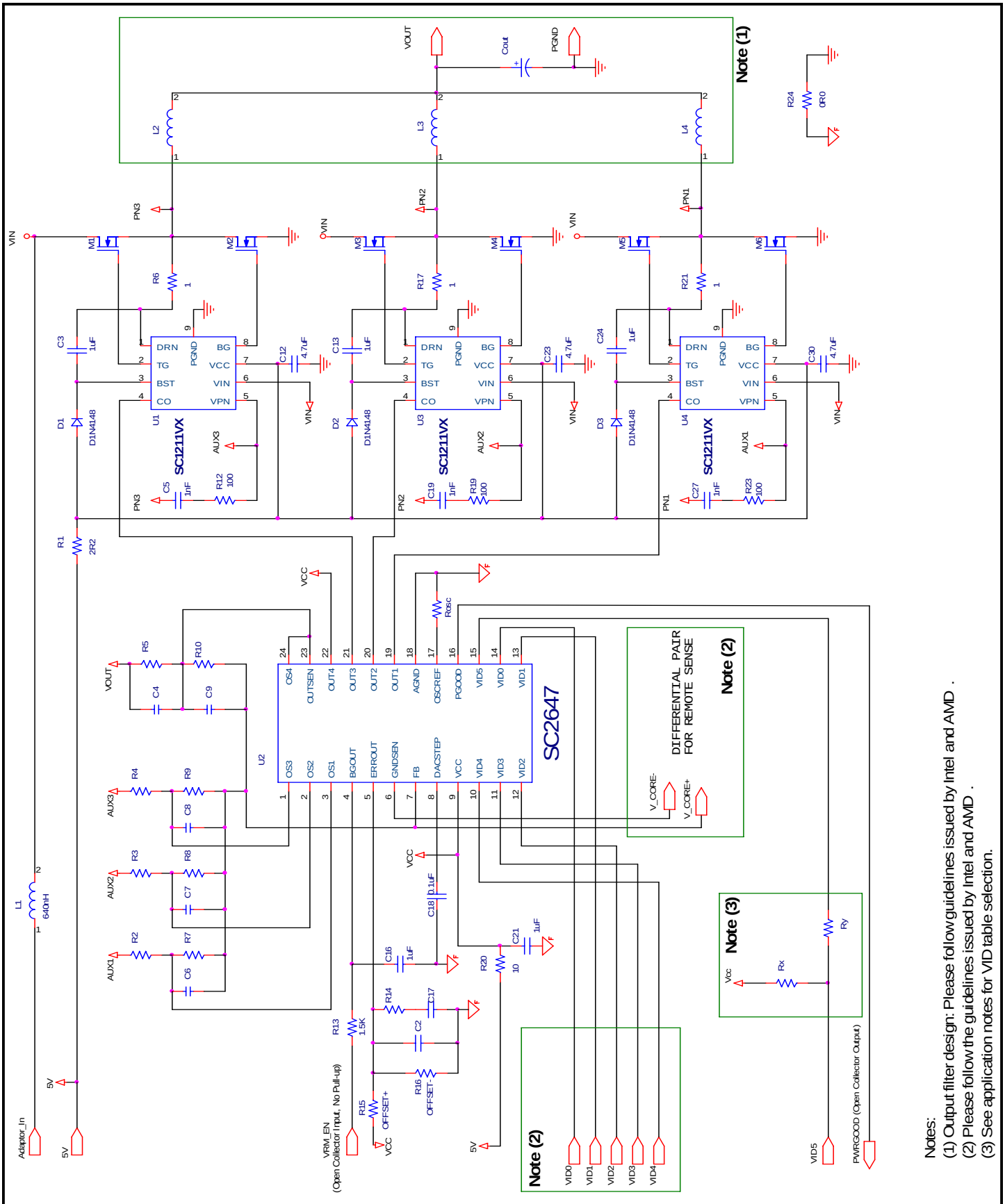
Features

- VRD/VRM10.0, VRM9.X, and K-8 compliant
- Core Voltage Set Point Accuracy 0.5%
- Combi-Sense™ Current Mode Control
- Intrinsic Phase Current Matching
- Fast Transient Responses
- Active Droop with Temperature Compensation to Meet Load Line Slope
- Support VID-on-Fly with 5 or 6 bit VID
- Enable Function for Power Sequencing
- Cycle-by-Cycle Peak Current Limit
- Intelligent Over Current Shut Down
- Over Voltage Protection When Using Semtech Combi-Sense™ Driver/1211VX
- Under Voltage Protection Built in
- External programmable Soft-Start
- Externally programmable switching frequency.
- 2, 3, or 4-Phase Configurations
- 24-Pin SOIC or TSSOP Packages
- This device is fully WEEE and RoHS Compliant

Applications

- Voltage Regulator VRD/VRM10.0
- Voltage Regulator VRM9.X
- Voltage Regulator K-8
- High Current, Low Voltage Step Down DC/DC Converters

Typical Application Circuit



Notes:
(1) Output filter design: Please follow guidelines issued by Intel and AMD .
(2) Please follow the guidelines issued by Intel and AMD .
(3) See application notes for VID table selection.

Absolute Maximum Ratings

Exceeding the specifications below may result in permanent damage to the device, or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not implied.

Parameter	Symbol	Maximum	Units
Supply Voltage	V_{CC}	20	V
Combi-Sense/Direct Output Voltage	OS1, OS2, OS3, OS4, OUTSEN	5	V
Ambient Temperature Range	T_A	0 to 105	°C
Junction Temperature Range	T_J	0 to 125	°C
Storage Temperature Range	T_{STG}	-65 to +150	°C
Lead Temperature (Soldering) 10 Sec.	T_{LEAD}	300	°C
ESD Rating (Human Body Model)	ESD	2	kV

Electrical Characteristics

Unless specified: V_{cc} = 5V, VID=1.30V (110110,VRD10) or 1.50V (101110,VRD10), F_{osc} = 600kHz, T_A = 27°C. See Typical Application Circuit.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Chip_Supply						
IC Supply Voltage	V_{CC}		4.7	5	7	V
IC Supply Current	I_{CC}			9.5		mA
UVLO Ramp Up				4.3		V
UVLO Hysterisis				300		mV
Reference Section						
Bandgap Output	V_{BGOUT}	C_{BGOUT} = 4.7nF		3		V
Source Current		BG=0V		270		µA
Sink Current		BG=4V		-500		µA
Supply Rejection		V_{CC} = 4.7V ~ 7V		0.5		mV/V
Temperature Stability		0°C < T_A < 85°C		0.5		%
VID Step		VRM9.X, K-8, LSB		25		mV
VID Step		VRD/VRM10, LSB		12.5		mV
Voltage Accuracy	V_{OUT}	VRD10 ; Internal offset=-20mV	-0.5		+0.5	%
		VRM9.x ; Internal offset=-20mV	-1		+1	%
		K-8 ; Internal offset=+25mV	-1		+1	%
Oscillator Section						
Oscillator Frequency		R_{OSC} = 309Kohm	540	600	660	kHz
Temperature Stability		0°C < T_A < 85°C		+/-5		%

Electrical Characteristics (Cont.)

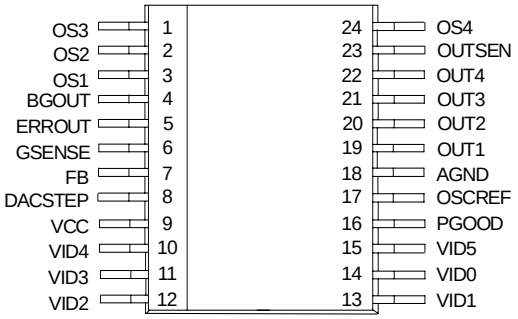
Unless specified: V_{CC} = 5V, VID=1.30V (110110,VRD10) or 1.50V (101110,VRD10), F_{OSC} = 600kHz, T_A = 27°C. See Typical Application Circuit.

Parameter	Test Conditions	Min	Typ	Max	Units
Voltage Error Amplifier					
Input Offset Voltage			+/-3		mV
Input Bias Current			25		nA
Open Loop Gain	1V < V_{ERROUT} < 3.6V		80		dB
Unity Gain Bandwidth	C_{ERROUT} = 10pF		10		MHz
Slew Rate			2		V/µS
Transconductance Gain			0.5		mA/V
Current Sense Amplifiers					
Input Offset Voltage			+/-3		mV
Input Bias Current			50		nA
Gain			9.5		V/V
CMRR	0 to 3V		80		dB
Input Common Mode Range		-0.3		3	V
Gain Match			2		%
Bandwidth			6		MHz
Droop Amplifier					
Gain			5.2		V/V
VIDs					
Logic Threshold	[VID0:4]	1.2		1.8	V
Pull-up Impedance	[VID0:4]		10		Kohm
VID5 Logic Threshold for VRD/VRM10	VID5	1.2		1.8	V
VID5 Clamping voltage			2.7		V
VID5 Selection Threshold for VRM9.X	VID5/Sink		49		uA
VID5 Selection Threshold for K-8	VID5/Sink		205		uA
3-Phase Operation					
Output 4 pull up Threshold		3.7	4.1		V
Power Good					
Threshold Rising	VID - Power Good Threshold		330		mV
Threshold Falling	VID - Power Good Threshold		560		mV
Output High Leakage	Pwrgood = V_{CC}		100		nA
Output Low Sink	Pwrgood = 0.8V	2			mA
Current Limit Section					
Max. Error Amp Voltage for Current Limit			3.6		V
Shutdown Voltage	VID - Shut Down Threshold		600		mV

POWER MANAGEMENT

Pin Configurations

Top View



(24-Pin SOIC/TSSOP)

Ordering Information

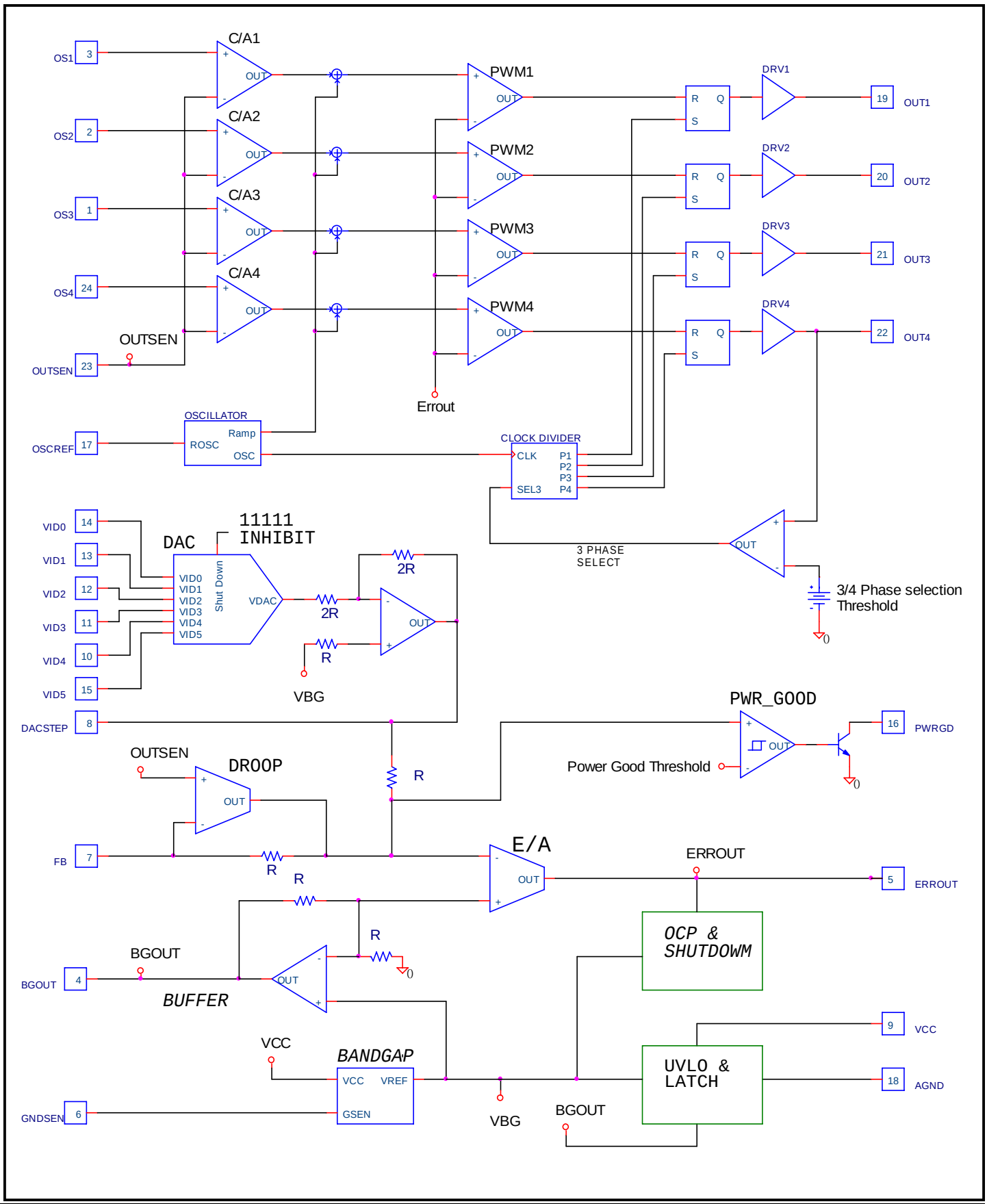
Part Number	Package	Temp. Range (T_J)
SC2647SWTR (1)	SOIC-24	0 to 125 °C
SC2647TSTR (1)	TSSOP-24	0 to 125 °C
SC2647TSTRT (1,3)	TSSOP-24	0 to 125 °C
SC2647EVB (2)	Evaluation Board	

Note:
(1) Only available in tape and reel packaging. A reel contains 1000 devices for the SOIC-24 and 2500 devices for the TSSOP-24 package.
(2) Specify SOIC-24 or TSSOP-24 package.
(3) Lead free product. This product is fully WEEE and RoHS compliant.

Pin Descriptions

Pin#	Pin Name	Pin Function
1	OS3	Current sense input.
2	OS2	Current sense input.Connect to OUTSEN for 2 phase operation.
3	OS1	Current sense input.
4	BGOUT	BG reference pin.Connect soft start cap from this pin to AGND.
5	ERROUT	Error-amplifier output.Connect compensation network to AGND.
6	GSENSE	Remote sense for GND.
7	FB	Feedback pin.Route FB and GENSE as differential pair to CPU.
8	DACSTEP	VID step speed.Connect a cap from this pin to AGND to filter DAC output.
9	VCC	Power supply for chip.
10~14	VID4 : 0	VID MSB to VID LSB.
15	VID5	12.5mV bit for VRD10.x. Pull it up to >2V and program the sink current to selectVRM9 or K8 VID table.
16	PGOOD	Power good, Open collector output.
17	OSCREF	Oscillator frequency setting .Connect a resistor to AGND.
18	AGND	Clean ground for analog signals.
19	OUT1	PWM output1.
20	OUT2	PWM output2.
21	OUT3	PWM output3.
22	OUT4	PWM output4. Connect to VCC for 3 phase operation.
23	OUTSEN	Direct output sense.
24	OS4	Current sense input. Connect to OUTSEN for 2 or 3 phase operation.

Block Diagram



Applications Information- Output Voltage

VRM9.X Output Voltage					
Unless specified: 0 = GND; 1 = High (or Floating). T_A = 25°C, V_{CC} = 5V					Vout (V)
VID4	**VID3**	**VID2**	**VID1**	**VID0**	
1	1	1	1	1	OFF
1	1	1	1	0	1.1
1	1	1	0	1	1.125
1	1	1	0	0	1.15
1	1	0	1	1	1.175
1	1	0	1	0	1.2
1	1	0	0	1	1.225
1	1	0	0	0	1.25
1	0	1	1	1	1.275
1	0	1	1	0	1.3
1	0	1	0	1	1.325
1	0	1	0	0	1.35
1	0	0	1	1	1.375
1	0	0	1	0	1.4
1	0	0	0	1	1.425
1	0	0	0	0	1.45
0	1	1	1	1	1.475
0	1	1	1	0	1.5
0	1	1	0	1	1.525
0	1	1	0	0	1.55
0	1	0	1	1	1.575
0	1	0	1	0	1.6
0	1	0	0	1	1.625
0	1	0	0	0	1.65
0	0	1	1	1	1.675
0	0	1	1	0	1.7
0	0	1	0	1	1.725
0	0	1	0	0	1.75
0	0	0	1	1	1.775
0	0	0	1	0	1.8
0	0	0	0	1	1.825
0	0	0	0	0	1.85

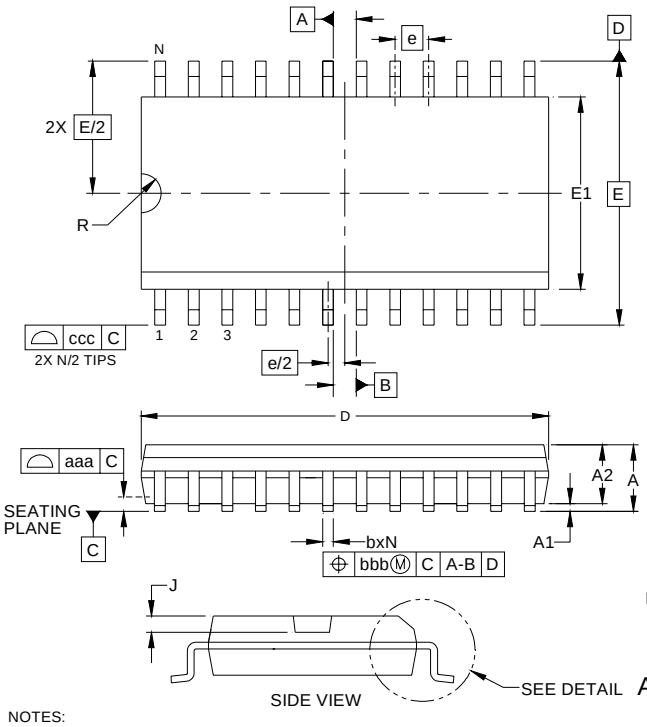
VRD10 Output Voltage						
Unless specified: 0 = GND; 1 = High. T_A = 25°C, V_{CC} = 5V						Vout (V)
VID5	VID4	VID3	VID2	VID1	VID0	
0	0	1	0	1	0	0.8375
1	0	1	0	0	1	0.8500
0	0	1	0	0	1	0.8625
1	0	1	0	0	0	0.8750
0	0	1	0	0	0	0.8875
1	0	0	1	1	1	0.9000
0	0	0	1	1	1	0.9125
1	0	0	1	1	0	0.9250
0	0	0	1	1	0	0.9375
1	0	0	1	0	1	0.9500
0	0	0	1	0	1	0.9625
1	0	0	1	0	0	0.9750
0	0	0	1	0	0	0.9875
1	0	0	0	1	1	1.0000
0	0	0	0	1	1	1.0125
1	0	0	0	1	0	1.0250
0	0	0	0	1	0	1.0375
1	0	0	0	0	1	1.0500
0	0	0	0	0	1	1.0625
1	0	0	0	0	0	1.0750
0	0	0	0	0	0	1.0875
1	1	1	1	1	1	OFF
0	1	1	1	1	1	OFF
1	1	1	1	1	0	1.1000
0	1	1	1	1	0	1.1125
1	1	1	1	0	1	1.1250
0	1	1	1	0	1	1.1375
1	1	1	1	0	0	1.1500
0	1	1	1	0	0	1.1625
1	1	1	0	1	1	1.1750
0	1	1	0	1	1	1.1875
1	1	1	0	1	0	1.2000
0	1	1	0	1	0	1.2125
1	1	1	0	0	1	1.2250
0	1	1	0	0	1	1.2375
1	1	1	0	0	0	1.2500
0	1	1	0	0	0	1.2625
1	1	0	1	1	1	1.2750
0	1	0	1	1	1	1.2875
1	1	0	1	1	0	1.3000
0	1	0	1	1	0	1.3125
1	1	0	1	0	1	1.3250
0	1	0	1	0	1	1.3375
1	1	0	1	0	0	1.3500
0	1	0	1	0	0	1.3625
1	1	0	0	1	1	1.3750
0	1	0	0	1	1	1.3875
1	1	0	0	1	0	1.4000
0	1	0	0	1	0	1.4125
1	1	0	0	0	1	1.4250
0	1	0	0	0	1	1.4375
1	1	0	0	0	0	1.4500
0	1	0	0	0	0	1.4625
1	0	1	1	1	1	1.4750
0	0	1	1	1	1	1.4875
1	0	1	1	1	0	1.5000
0	0	1	1	1	0	1.5125
1	0	1	1	0	1	1.5250
0	0	1	1	0	1	1.5375
1	0	1	1	0	0	1.5500
0	0	1	1	0	0	1.5625
1	0	1	0	1	1	1.5750
0	0	1	0	1	1	1.5875
1	0	1	0	1	0	1.6000

Applications Information- Output Voltag

K-8 Output Voltage					
Unless specified: 0 = GND; 1 = High (or Floating). T_A = 25°C, V_{CC} = 5V					
VID4	**VID3**	**VID2**	**VID1**	**VID0**	**V_{OUT} (V)**
0	0	0	0	0	1.550
0	0	0	0	1	1.525
0	0	0	1	0	1.500
0	0	0	1	1	1.475
0	0	1	0	0	1.450
0	0	1	0	1	1.425
0	0	1	1	0	1.400
0	0	1	1	1	1.375
0	1	0	0	0	1.350
0	1	0	0	1	1.325
0	1	0	1	0	1.300
0	1	0	1	1	1.275
0	1	1	0	0	1.250
0	1	1	0	1	1.225
0	1	1	1	0	1.200
0	1	1	1	1	1.175
1	0	0	0	0	1.150
1	0	0	0	1	1.125
1	0	0	1	0	1.100
1	0	0	1	1	1.075
1	0	1	0	0	1.050
1	0	1	0	1	1.025
1	0	1	1	0	1.000
1	0	1	1	1	0.975
1	1	0	0	0	0.950
1	1	0	0	1	0.925
1	1	0	1	0	0.900
1	1	0	1	1	0.875
1	1	1	0	0	0.850
1	1	1	0	1	0.825
1	1	1	1	0	0.800
1	1	1	1	1	OFF

POWER MANAGEMENT

Outline Drawing - SOIC-24

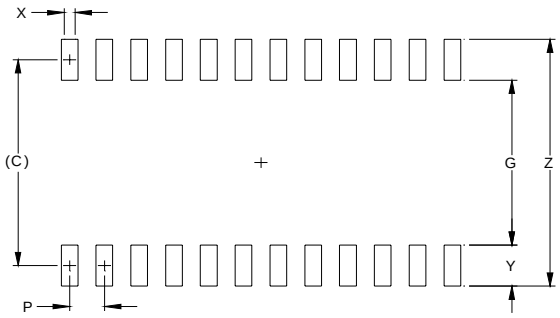


DIM	DIMENSIONS					
	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.093	-	.104	2.35	-	2.65
A1	.004	-	.012	0.10	-	0.30
A2	.081	-	.100	2.05	-	2.55
b	.012	-	.020	0.31	-	0.51
c	.008	-	.013	0.20	-	0.33
D	.602	.606	.610	15.30	15.40	15.50
E1	.291	.295	.299	7.40	7.50	7.60
E	.406 BSC			10.30 BSC		
e	.050 BSC			1.27 BSC		
h	.010	-	.030	0.25	-	0.75
J	.020	-	.030	0.50	-	0.75
L	.016	-	.041	0.40	-	1.04
L1	(.041)			(1.04)		
N	24			24		
R	.024	-	.035	0.60	-	0.90
θ1	0	-	8	0	-	8
aaa	.004			0.10		
bbb	.010			0.25		
ccc	.013			0.33		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS -A- AND -B- TO BE DETERMINED AT DATUM PLANE -H-
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
4. REFERENCE JEDEC STD MS-013, VARIATION AD.

Land Pattern - SOIC-24



DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.362)	(9.20)
G	.276	7.00
P	.050	1.27
X	.024	0.60
Y	.087	2.20
Z	.449	11.40

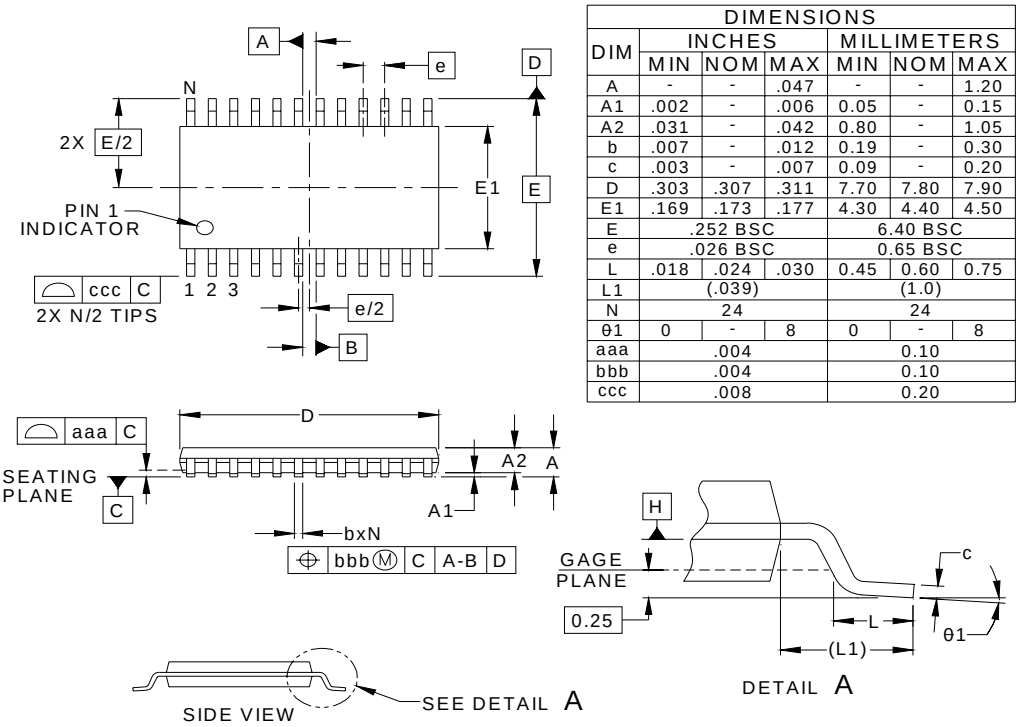
NOTES:

1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
2. REFERENCE IPC-SM-782A, RLP NO. 307A.

Contact Information

Semtech Corporation
Power Management Products Division
200 Flynn Rd., Camarillo, CA 93012
Phone: (805)498-2111 FAX (805)498-3804

Outline Drawing - TSSOP-24

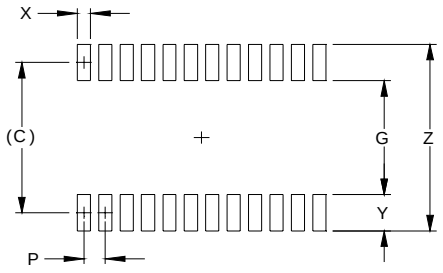


DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	-	-	.047	-	-	1.20
A1	.002	-	.006	0.05	-	0.15
A2	.031	-	.042	0.80	-	1.05
b	.007	-	.012	0.19	-	0.30
c	.003	-	.007	0.09	-	0.20
D	.303	.307	.311	7.70	7.80	7.90
E1	.169	.173	.177	4.30	4.40	4.50
E	.252 BSC			6.40 BSC		
e	.026 BSC			0.65 BSC		
L	.018	.024	.030	0.45	0.60	0.75
L1	(.039)			(1.0)		
N	24			24		
θ1	0	-	8	0	-	8
aaa	.004			0.10		
bbb	.004			0.10		
ccc	.008			0.20		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS -A- AND -B- TO BE DETERMINED AT DATUM PLANE -H-
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
4. REFERENCE JEDEC STD MO-153, VARIATION AD.

Land Pattern - TSSOP-24



DIM	INCHES	MILLIMETERS
C	(.222)	(5.65)
G	.161	4.10
P	.026	0.65
X	.016	0.40
Y	.061	1.55
Z	.283	7.20

NOTES:

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